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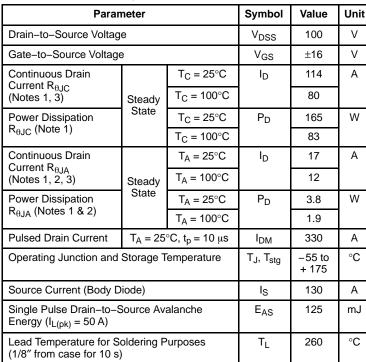
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Power MOSFET 100 V, 5.6 mΩ, 114 A, Single N–Channel

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS6B05NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)



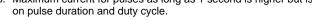
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	R_{\thetaJC}	0.9	°C/W
Junction-to-Ambient - Steady State (Note 2)	R_{\thetaJA}	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
Maximum current for pulses as long as 1 second is higher but is dependent

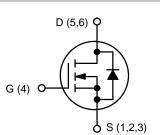




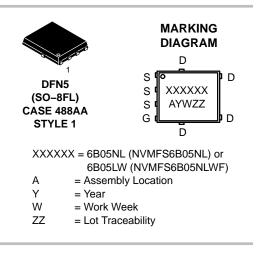
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX	
100 V	5.6 mΩ @ 10 V	114 A	
	8.2 mΩ @ 4.5 V	1177	



N-CHANNEL MOSFET



ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

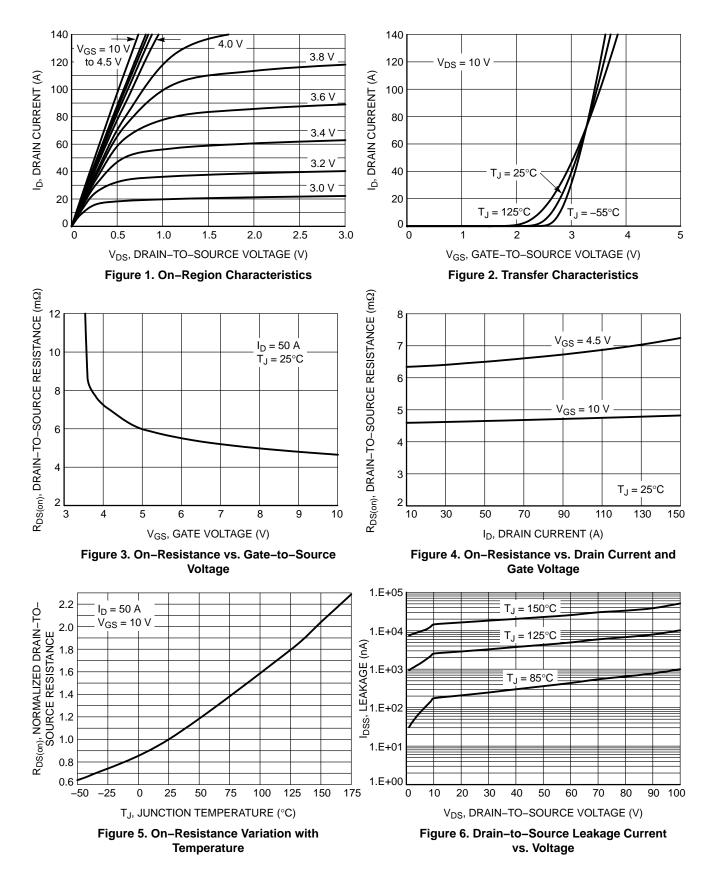
Semiconductor Components Industries, LLC, 2016 January, 2016 – Rev. 0

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 250 \mu A$		100			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				62.9		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	T _J = 25 °C			25	
		V _{DS} = 80 V	T _J = 125°C			250	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$	_S = 16 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$		1.0		3.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.8		mV/°C
Drain-to-Source On Resistance		$V_{GS} = 10 V$			4.7	5.6	mΩ
	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 20 A		6.5	8.2	
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			3980		pF
Output Capacitance	C _{OSS}				1370		
Reverse Transfer Capacitance	C _{RSS}				89		
Total Gate Charge		V_{GS} = 4.5 V, V_{DD} = 50 V, I_{D} = 50 A			24.6		-
	Q _{G(TOT)}				52.5		
Threshold Gate Charge	Q _{G(TH)}				6.8		nC
Gate-to-Source Charge	Q _{GS}	$V_{GS} = 10 \text{ V}, V_{DS} = 50 \text{ V}; I_D = 50 \text{ A}$			12		
Gate-to-Drain Charge	Q _{GD}				5.9		
Plateau Voltage	V _{GP}				3.2		V
SWITCHING CHARACTERISTICS (Note	5)						
Turn-On Delay Time	t _{d(ON)}				17.3		1
Rise Time	tr	V_{GS} = 10 V, V_{DS} = 50 V, I_{D} = 25 A, R_{G} = 2.5 Ω			84		ns
Turn-Off Delay Time	t _{d(OFF)}				28.4		
Fall Time	t _f				83.2		
DRAIN-SOURCE DIODE CHARACTERI	STICS						
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 25 A$	$T_J = 25^{\circ}C$		0.84	1.2	v
			T _J = 125°C		0.72		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 25 A			60.6		ns
Charge Time	t _a				31.4		
Discharge Time	t _b				29.2		
Reverse Recovery Charge	Q _{RR}				82		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \,\mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

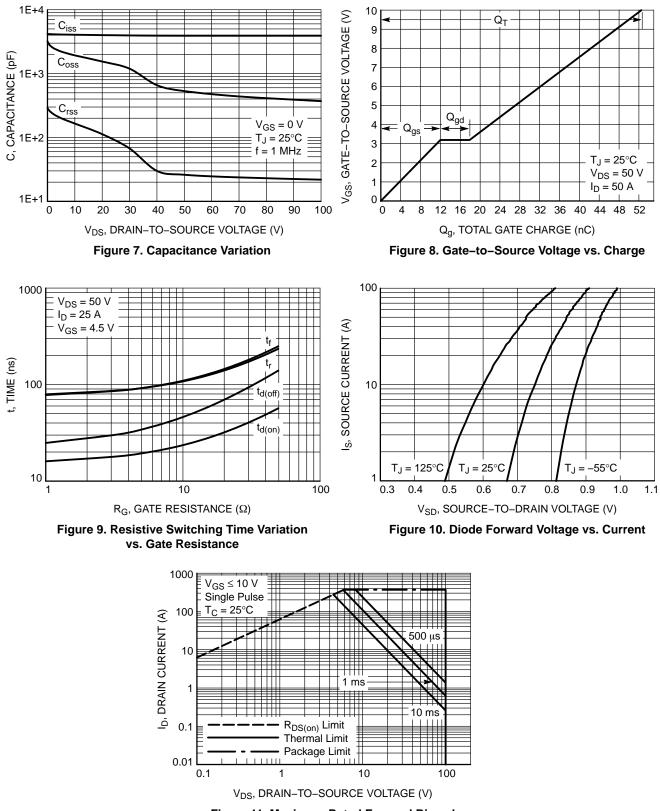


Figure 11. Maximum Rated Forward Biased Safe Operating Area

TYPICAL CHARACTERISTICS

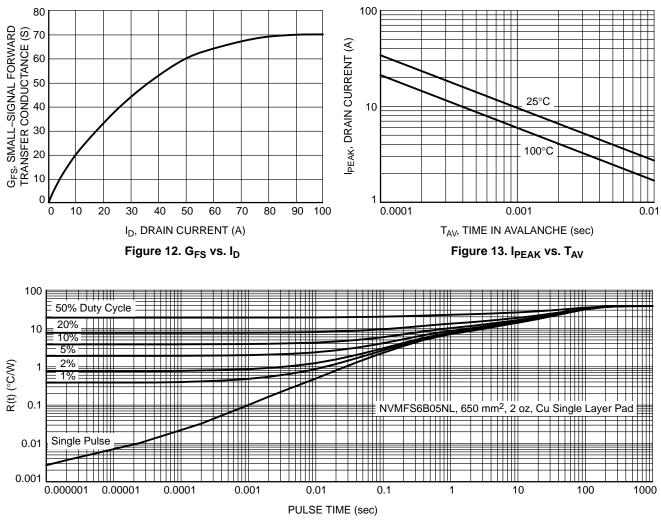


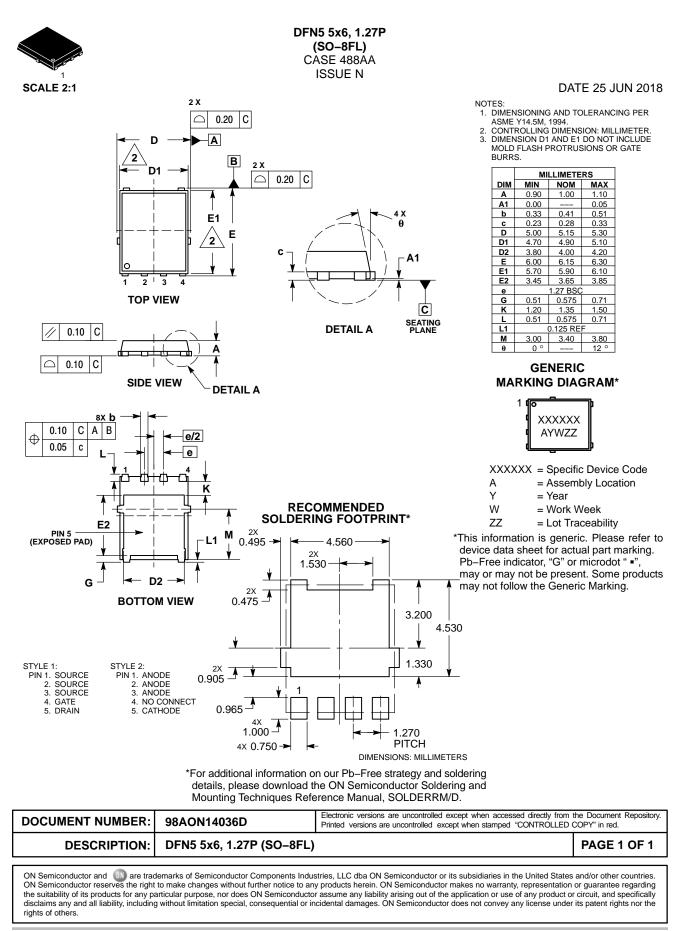
Figure 14. Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS6B05NLT1G	6B05NL	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS6B05NLWFT1G	605LW	DFN5 (Pb–Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS6B05NLT3G	6B05NL	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS6B05NLWFT3G	605LW	DFN5 (Pb–Free, Wettable Flanks)	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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